

2SJ683-VB Datasheet

P-Channel 60-V (D-S) 175 °C MOSFET

PRODUCT SUMMARY

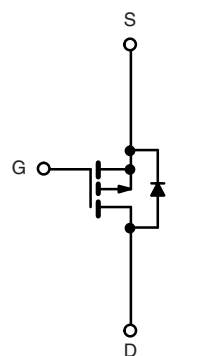
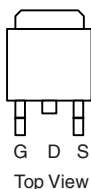
V_{DS} (V)	$R_{DS(on)}$ (Ω)	I_D (A) ^d
- 60	0.0065 at $V_{GS} = - 10$ V	- 110
	0.0085 at $V_{GS} = - 4.5$ V	

FEATURES

- TrenchFET[®] Power MOSFET
- Package with Low Thermal Resistance
- 100 % R_g Tested


 Available
RoHS*
 COMPLIANT

TO-263



P-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS $T_C = 25\text{ }^{\circ}\text{C}$, unless otherwise noted

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	- 60	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ^d ($T_J = 175\text{ }^{\circ}\text{C}$)	I_D	$T_C = 25\text{ }^{\circ}\text{C}$ - 110	A
		$T_C = 125\text{ }^{\circ}\text{C}$ - 75	
Pulsed Drain Current	I_{DM}	- 200	
Avalanche Current	I_{AS}	- 85	
Single Pulse Avalanche Energy ^d	E_{AS}	211	mJ
Maximum Power Dissipation	P_D	$T_C = 25\text{ }^{\circ}\text{C}$ 272 ^c	W
		$T_A = 25\text{ }^{\circ}\text{C}^b$ 3.75 ^b	
Operating Junction and Storage Temperature Range	T_J, T_{stg}	- 55 to 175	$^{\circ}\text{C}$

THERMAL RESISTANCE RATINGS

Parameter	Symbol	Limit	Unit
Junction-to-Ambient	R_{thJA}	40	$^{\circ}\text{C}/\text{W}$
Junction-to-Case	R_{thJC}	0.55	

Notes:

- a. Duty cycle $\leq 1\%$.
 b. When Mounted on 1" square PCB (FR-4 material).
 c. See SOA curve for voltage derating.
 d. Limited by Package.

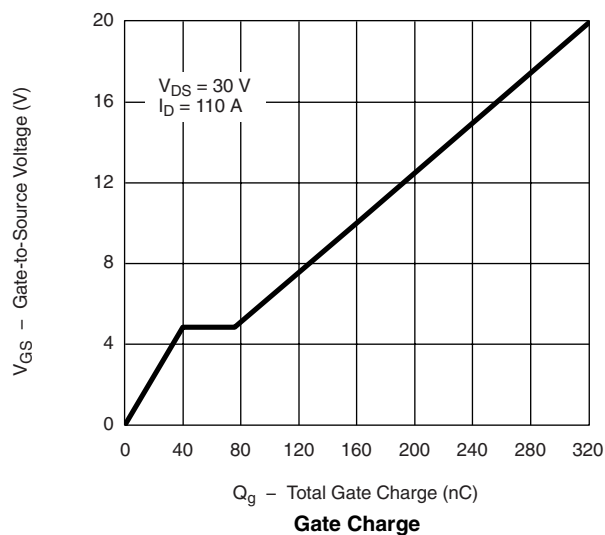
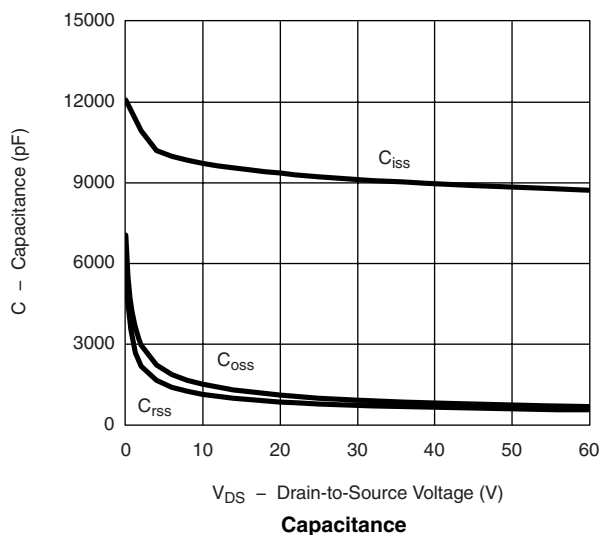
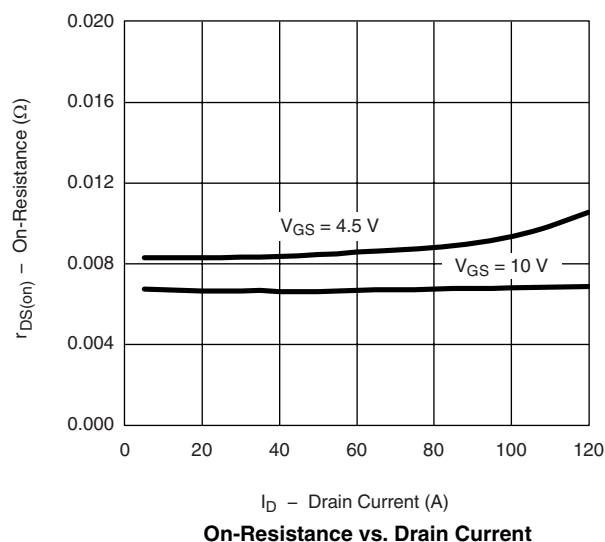
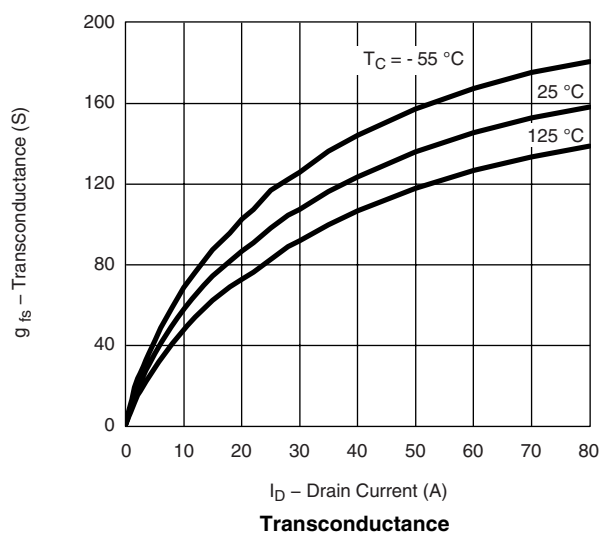
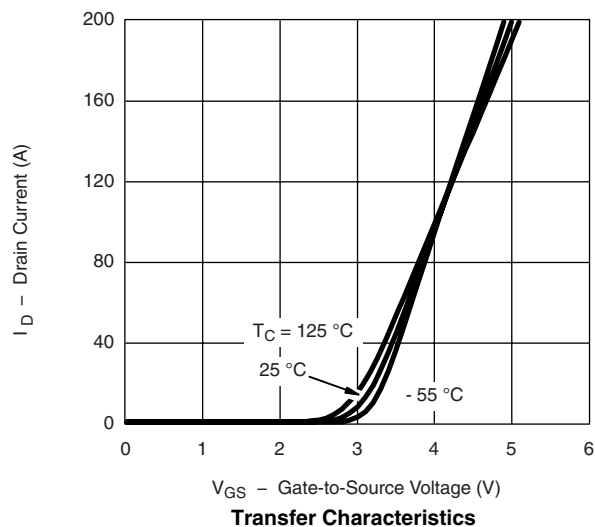
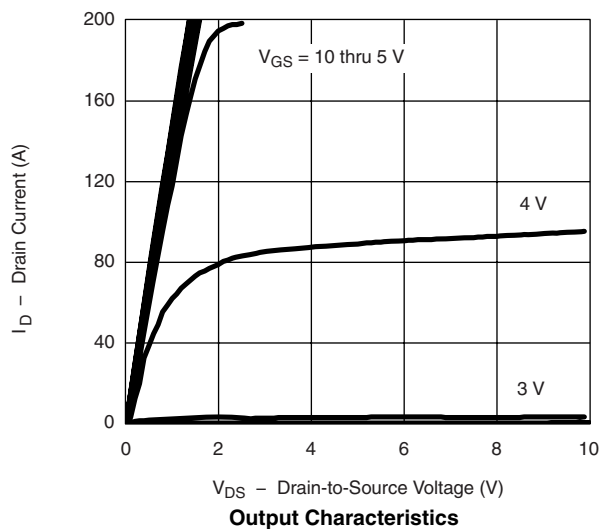
* Pb containing terminations are not RoHS compliant, exemptions may apply.

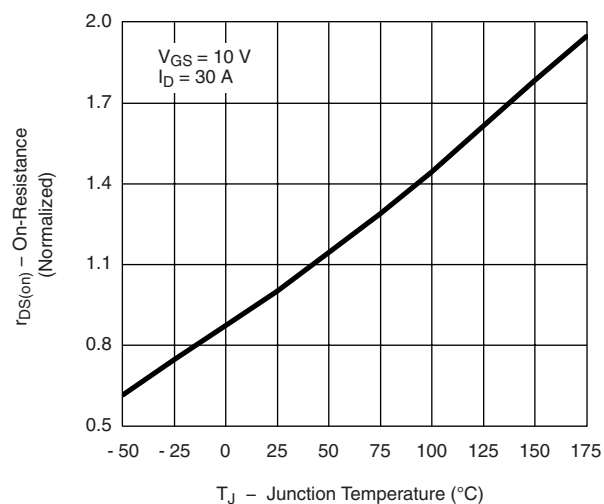
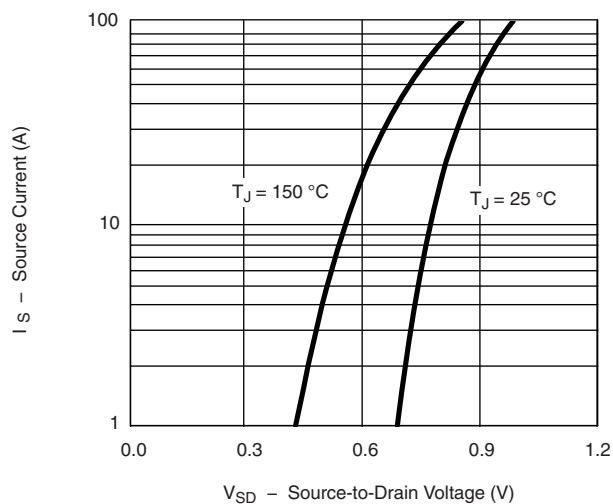
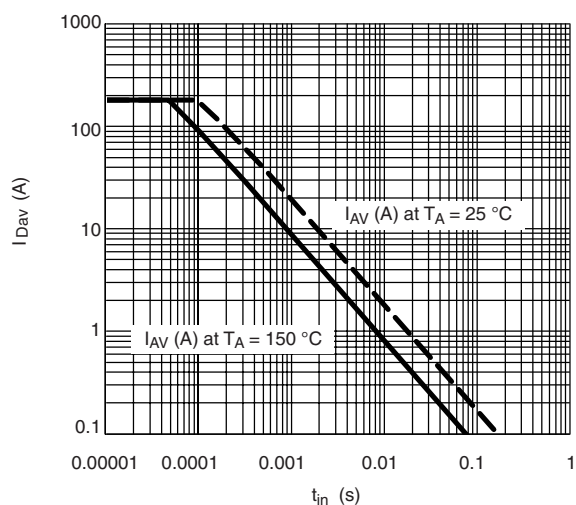
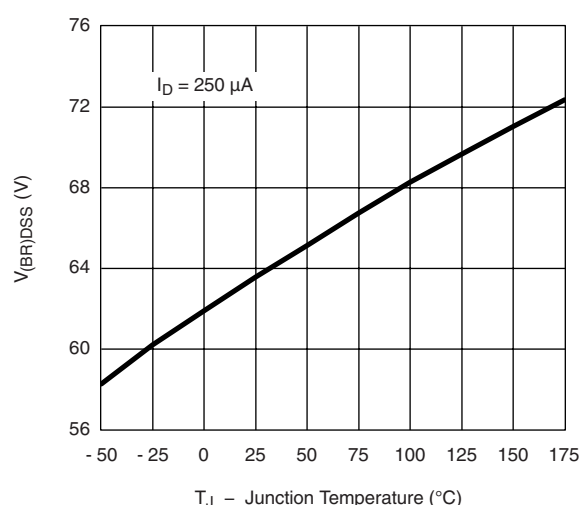
SPECIFICATIONS T _J = 25 °C, unless otherwise noted						
Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} = 0 V, I _D = - 250 μA	- 60			V
Gate-Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = - 250 μA	- 1		- 3	
Gate-Body Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 20 V			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = - 60 V, V _{GS} = 0 V			- 1	μA
		V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 125 °C			- 50	
		V _{DS} = - 60 V, V _{GS} = 0 V, T _J = 175 °C			- 250	
On-State Drain Current ^a	I _{D(on)}	V _{DS} = - 5 V, V _{GS} = - 10 V	- 120			A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 10 V, I _D = - 30 A		0.0065		Ω
		V _{GS} = - 10 V, I _D = - 30 A, T _J = 125 °C		0.0129		
		V _{GS} = - 10 V, I _D = - 30 A, T _J = 175 °C		0.016		
		V _{GS} = - 4.5 V, I _D = - 20 A		0.0085		
Forward Transconductance ^a	g _{fs}	V _{DS} = - 15 V, I _D = - 50 A	20			S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{GS} = 0 V, V _{DS} = - 25 V, f = 1 MHz		9200		pF
Output Capacitance	C _{oss}			975		
Reverse Transfer Capacitance	C _{rss}			760		
Total Gate Charge ^c	Q _g	V _{DS} = - 30 V, V _{GS} = - 10 V, I _D = - 110 A		160	240	nC
Gate-Source Charge ^c	Q _{gs}			40		
Gate-Drain Charge ^c	Q _{gd}			36		
Gate Resistance	R _g	f = 1 MHz	1.5	3	4.5	Ω
Turn-On Delay Time ^c	t _{d(on)}	V _{DD} = - 30 V, R _L = 0.27 Ω I _D ≅ - 110 A, V _{GEN} = - 10 V, R _G = 2.5 Ω		20	30	ns
Rise Time ^c	t _r			190	285	
Turn-Off Delay Time ^c	t _{d(off)}			140	210	
Fall Time ^c	t _f			300	450	
Source-Drain Diode Ratings and Characteristics T _C = 25 °C ^b						
Continuous Current	I _S				- 110	A
Pulsed Current	I _{SM}				- 200	
Forward Voltage ^a	V _{SD}	I _F = - 50 A, V _{GS} = 0 V		- 1.0	- 1.5	V
Reverse Recovery Time	t _{rr}	I _F = - 50 A, di/dt = 100 A/μs		60	90	ns
Peak Reverse Recovery Charge	I _{RM(REC)}			- 3	- 4.5	A
Reverse Recovery Charge	Q _{rr}				0.09	0.2

Notes:

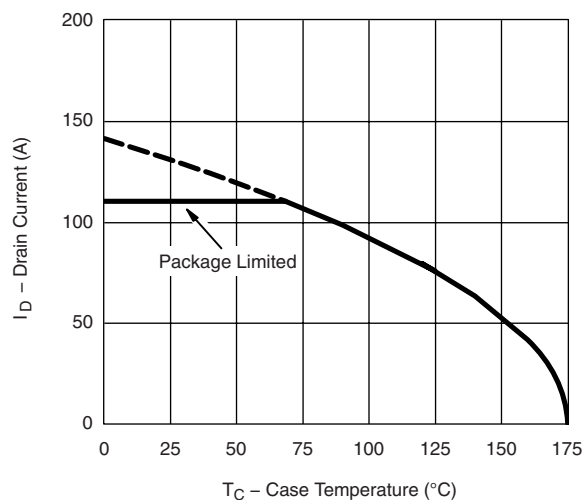
- a. Pulse test; pulse width $\leq 300\text{ }\mu\text{s}$, duty cycle $\leq 2\%$.
 b. Guaranteed by design, not subject to production testing.
 c. Independent of operating temperature.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

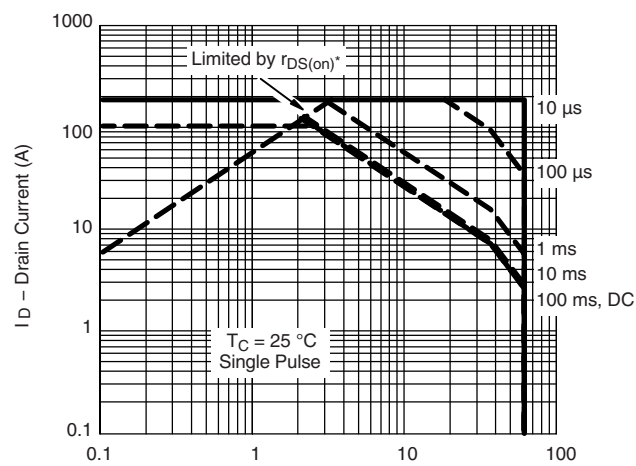
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted


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On-Resistance vs. Junction Temperature

Source-Drain Diode Forward Voltage

Avalanche Current vs. Time

Drain Source Breakdown vs. Junction Temperature

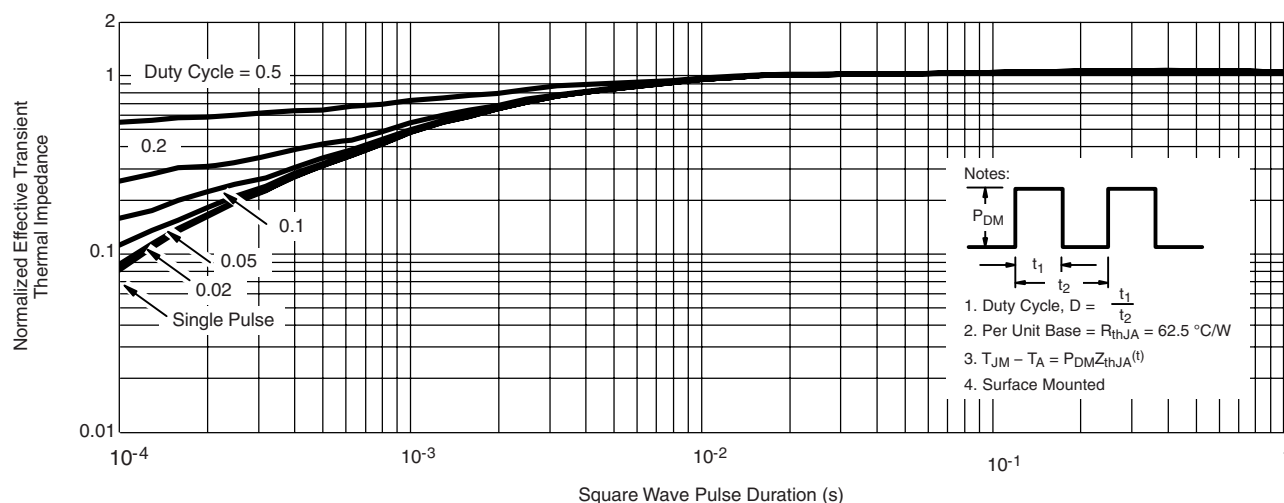
THERMAL RATINGS



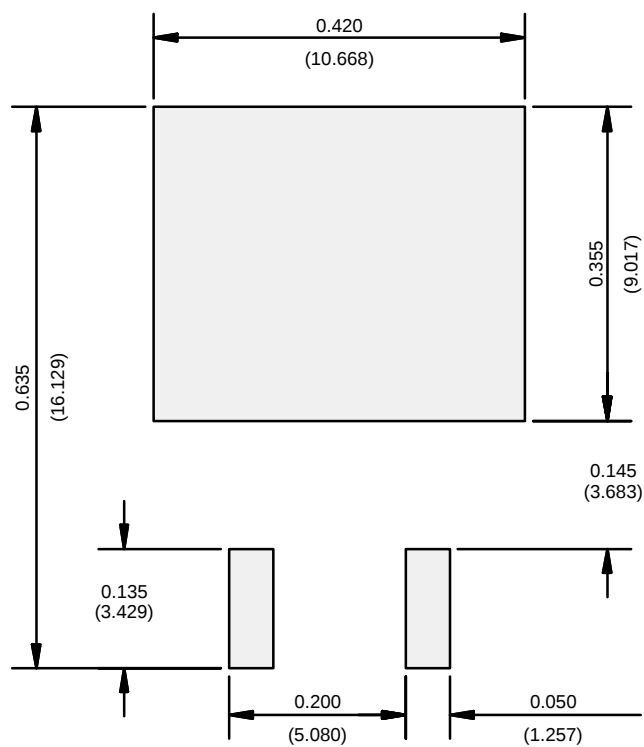
**Maximum Avalanche and Drain Current
vs. Case Temperature**



Safe Operating Area
* $V_{GS} >$ minimum V_{GS} at which $r_{DS(on)}$ is specified



Normalized Thermal Transient Impedance, Junction-to-Case

RECOMMENDED MINIMUM PADS FOR D²PAK: 3-Lead

Recommended Minimum Pads
Dimensions in Inches/(mm)

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